INFORMATION DISCLOSURE STATEMENT			SERIAL NUMBER 09/987,950 DOCKET NO.			P56574	
OIF	10-1449 (PAGI	APPLICANT HEE-CHUN PARK					
	6 2005 25		FILING DATE 16 Novemb	er 2001	GROUP	2654	
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EXAMINER	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING	DATE
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		FOREIGN PATENT DO	CUMENTS			TRANSI	LATION
	DOCUMENT NUMBER	<u> </u>	COUNTRY	CLASS	SUBCLASS	YES	NO
AS	JP 2001-142600	5/01	JAPAN	<del></del>		Abstract	
AS	JP 09-081569	3/97	JAPAN			Abstract	
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		OCUMENTS (Including	Author, Title, Date, Per	tinent Pag	es, etc.)		
K		e Japanese Patent Offic -33188 (dated 25 Janua		s correspo	nding Kor	ean Patent	
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EXAMINER: ( ASCUL DIA DATE CONSIDERED: 6/22/05							
EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP §609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							

INFORMATION DISCLOSURE STATEMENT		To be assigned.	DOCKET NO.	P56574
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,	FILING DATE	16 November 2001	GROUP	To be assigned.

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AS	5,583,761	12/96	Chou	395	798		.s. 7950
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As	KR1995-27551	10/95	Korea			abstract	
AS	JP8-160930	06/96	Japan			abstract	
AS	JP9-114837	05/97	Japan			abstract	
AS	JP11-353074	12/99	Japan			abstract	
AS	JP2000-330992	11/00	Japan			abstract	
AS	JP2000-207399	07/00	Japan			abstract	
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<del></del>	01	HER DOCUM	ENTS (including Author, Title, Date, P	ertinent Pages, etc	)		
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